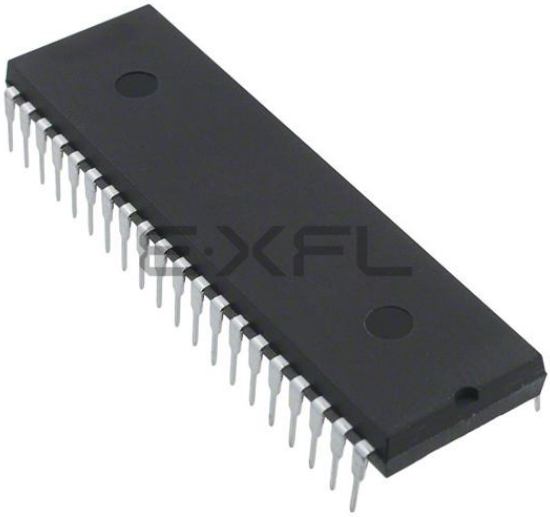

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RAM Size	2K x 8
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dsPIC30F Motor Control and Power Conversion Family

Device	Pins	Program Mem. Bytes/ Instructions	SRAM Bytes	EEPROM Bytes	Timer 16-bit	Input Cap	Output Comp/Std PWM	Motor Control PWM	10-bit A/D 1 Msps	Quad Enc	UART	SPI	I²C™	CAN
dsPIC30F4012	28	48K/16K	2048	1024	5	4	2	6 ch	6 ch	Yes	1	1	1	1
dsPIC30F4011	40/44	48K/16K	2048	1024	5	4	4	6 ch	9 ch	Yes	2	1	1	1

2.3 Divide Support

The dsPIC DSCs feature a 16/16-bit signed fractional divide operation, as well as 32/16-bit and 16/16-bit signed and unsigned integer divide operations, in the form of single instruction iterative divides. The following instructions and data sizes are supported:

1. DIVF – 16/16 signed fractional divide
2. DIV.sd – 32/16 signed divide
3. DIV.ud – 32/16 unsigned divide
4. DIV.s – 16/16 signed divide
5. DIV.u – 16/16 unsigned divide

The divide instructions must be executed within a REPEAT loop. Any other form of execution (e.g. a series of discrete divide instructions) will not function correctly because the instruction flow depends on RCOUNT. The divide instruction does not automatically set up the RCOUNT value and it must, therefore, be explicitly and correctly specified in the REPEAT instruction, as shown in Table 2-1 (REPEAT executes the target instruction {operand value + 1} times). The REPEAT loop count must be set up for 18 iterations of the DIV/DIVF instruction. Thus, a complete divide operation requires 19 cycles.

Note:	The divide flow is interruptible. However, the user needs to save the context as appropriate.

TABLE 2-1: DIVIDE INSTRUCTIONS

Instruction	Function
DIVF	Signed fractional divide: Wm/Wn →W0; Rem →W1
DIV.sd	Signed divide: (Wm + 1:Wm)/Wn →W0; Rem →W1
DIV.s	Signed divide: Wm/Wn →W0; Rem →W1
DIV.ud	Unsigned divide: (Wm + 1:Wm)/Wn →W0; Rem →W1
DIV.u	Unsigned divide: Wm/Wn →W0; Rem →W1

2.4 DSP Engine

The DSP engine consists of a high-speed, 17-bit x 17-bit multiplier, a barrel shifter and a 40-bit adder/subtracter (with two target accumulators, round and saturation logic).

The dsPIC30F devices have a single instruction flow which can execute either DSP or MCU instructions. Many of the hardware resources are shared between the DSP and MCU instructions. For example, the instruction set has both DSP and MCU multiply instructions which use the same hardware multiplier.

The DSP engine also has the capability to perform inherent accumulator-to-accumulator operations which require no additional data. These instructions are ADD, SUB and NEG.

The DS0 engine has various options selected through various bits in the CPU Core Configuration register (CORCON), as listed below:

1. Fractional or integer DSP multiply (IF).
2. Signed or unsigned DSP multiply (US).
3. Conventional or convergent rounding (RND).
4. Automatic saturation on/off for ACCA (SATA).
5. Automatic saturation on/off for ACCB (SATB).
6. Automatic saturation on/off for writes to data memory (SATDW).
7. Accumulator Saturation mode selection (ACCSAT).

Note:	For CORCON layout, see Table 3-3.

A block diagram of the DSP engine is shown in Figure 2-2.

TABLE 2-2: DSP INSTRUCTION SUMMARY

Instruction	Algebraic Operation
CLR	A = 0
ED	A = $(x – y)^2$
EDAC	A = A + $(x – y)^2$
MAC	A = A + (x * y)
MOVSAC	No change in A
MPY	A = x * y
MPY.N	A = – x * y
MSC	A = A – x * y

TABLE 4-2: BIT-REVERSED ADDRESS SEQUENCE (16-ENTRY)

Normal Address					Bit-Reversed Address				
A3	A2	A1	A0	Decimal	A3	A2	A1	A0	Decimal
0	0	0	0	0	0	0	0	0	0
0	0	0	1	1	1	0	0	0	8
0	0	1	0	2	0	1	0	0	4
0	0	1	1	3	1	1	0	0	12
0	1	0	0	4	0	0	1	0	2
0	1	0	1	5	1	0	1	0	10
0	1	1	0	6	0	1	1	0	6
0	1	1	1	7	1	1	1	0	14
1	0	0	0	8	0	0	0	1	1
1	0	0	1	9	1	0	0	1	9
1	0	1	0	10	0	1	0	1	5
1	0	1	1	11	1	1	0	1	13
1	1	0	0	12	0	0	1	1	3
1	1	0	1	13	1	0	1	1	11
1	1	1	0	14	0	1	1	1	7
1	1	1	1	15	1	1	1	1	15

TABLE 4-3: BIT-REVERSED ADDRESS MODIFIER VALUES FOR XBREV REGISTER

Buffer Size (Words)	XB<14:0> Bit-Reversed Address Modifier Value(1)
32768	0x4000
16384	0x2000
8192	0x1000
4096	0x0800
2048	0x0400
1024	0x0200
512	0x0100
256	0x0080
128	0x0040
64	0x0020
32	0x0010
16	0x0008
8	0x0004
4	0x0002
2	0x0001

Note 1: Modifier values for buffer sizes greater than 1024 words will exceed the available data memory on the dsPIC30F4011/4012 devices.

6.6.3 LOADING WRITE LATCHES

Example 6-2 shows a sequence of instructions that can be used to load the 96 bytes of write latches. 32 TBLWTL and 32 TBLWTH instructions are needed to load the write latches selected by the Table Pointer.

EXAMPLE 6-2: LOADING WRITE LATCHES

```
; Set up a pointer to the first program memory location to be written
; program memory selected, and writes enabled
        MOV     #0x0000,W0                      ;
        MOV     W0,TBLPAG                       ; Initialize PM Page Boundary SFR
        MOV     #0x6000,W0                      ; An example program memory address
; Perform the TBLWT instructions to write the latches
; 0th_program_word
        MOV     #LOW_WORD_0,W2                  ;
        MOV     #HIGH_BYTE_0,W3                 ;
        TBLWTL  W2,[W0]                         ; Write PM low word into program latch
        TBLWTH  W3,[W0++]                       ; Write PM high byte into program latch
; 1st_program_word
        MOV     #LOW_WORD_1,W2                  ;
        MOV     #HIGH_BYTE_1,W3                 ;
        TBLWTL  W2,[W0]                         ; Write PM low word into program latch
        TBLWTH  W3,[W0++]                       ; Write PM high byte into program latch
;  2nd_program_word
        MOV     #LOW_WORD_2,W2                  ;
        MOV     #HIGH_BYTE_2,W3                 ;
        TBLWTL  W2, [W0]                        ; Write PM low word into program latch
        TBLWTH  W3, [W0++]                      ; Write PM high byte into program latch
        •
        •
        •
; 31st_program_word
        MOV     #LOW_WORD_31,W2                 ;
        MOV     #HIGH_BYTE_31,W3                ;
        TBLWTL  W2, [W0]                        ; Write PM low word into program latch
        TBLWTH  W3, [W0++]                      ; Write PM high byte into program latch
```

Note: In Example 6-2, the contents of the upper byte of W3 have no effect.

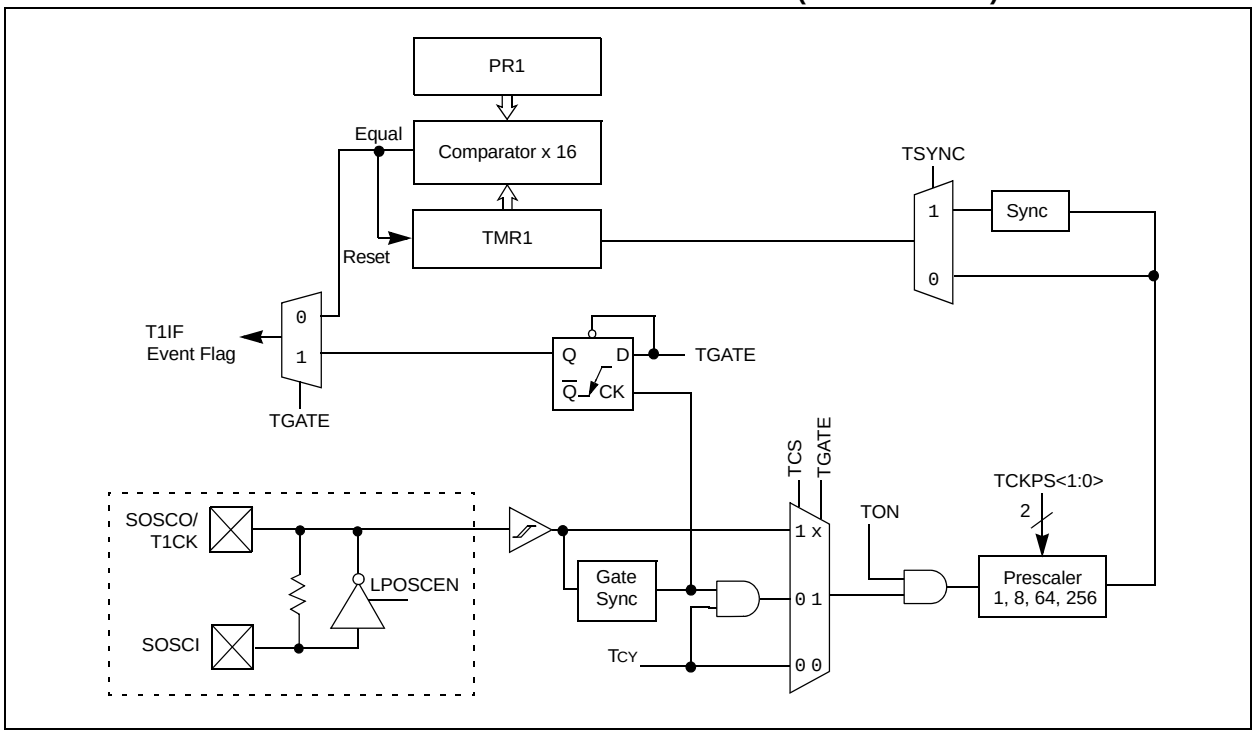
6.6.4 INITIATING THE PROGRAMMING SEQUENCE

For protection, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPs.

EXAMPLE 6-3: INITIATING A PROGRAMMING SEQUENCE

```
        DISI    #5                      ; Block all interrupts with priority < 7
                                        ; for next 5 instructions
        MOV     #0x55,W0
        MOV     W0,NVMKEY               ; Write the 0x55 key
        MOV     #0xAA,W1                ;
        MOV     W1,NVMKEY               ; Write the 0xAA key
        BSET    NVMCON,#WR              ; Start the erase sequence
        NOP                             ; Insert two NOPs after the erase
        NOP                             ; command is asserted
```

FIGURE 9-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM (TYPE A TIMER)



9.1 Timer Gate Operation

The 16-bit timer can be placed in the Gated Time Accumulation mode. This mode allows the internal TCY to increment the respective timer when the gate input signal (T1CK pin) is asserted high. Control bit, TGATE (T1CON<6>), must be set to enable this mode. The timer must be enabled (TON = 1) and the timer clock source set to internal (TCS = 0).

When the CPU goes into the Idle mode, the timer will stop incrementing unless TSIDL = 0. If TSIDL = 1, the timer will resume the incrementing sequence upon termination of the CPU Idle mode.

9.2 Timer Prescaler

The input clock (FOSC/4 or external clock) to the 16-bit Timer has a prescale option of 1:1, 1:8, 1:64 and 1:256 selected by control bits, TCKPS<1:0> (T1CON<5:4>). The prescaler counter is cleared when any of the following occurs:

- A write to the TMR1 register
- Clearing of the TON bit (T1CON<15>)
- A device Reset, such as a POR and BOR

However, if the timer is disabled (TON = 0), then the timer prescaler cannot be reset since the prescaler clock is halted.

The TMR1 register is not cleared when the T1CON register is written. It is cleared by writing to the TMR1 register.

9.3 Timer Operation During Sleep Mode

During CPU Sleep mode, the timer will operate if:

- The timer module is enabled (TON = 1) and
- The timer clock source is selected as external (TCS = 1) and
- The TSYNC bit (T1CON<2>) is asserted to a logic '0', which defines the external clock source as asynchronous

When all three conditions are true, the timer will continue to count up to the Period register and be reset to 0x0000.

When a match between the timer and the Period register occurs, an interrupt can be generated if the respective timer interrupt enable bit is asserted.

9.4 Timer Interrupt

The 16-bit timer has the ability to generate an interrupt on period match. When the timer count matches the Period register, the T1IF bit is asserted and an interrupt will be generated, if enabled. The T1IF bit must be cleared in software. The Timer Interrupt Flag, T1IF, is located in the IFS0 control register in the interrupt controller.

When the Gated Time Accumulation mode is enabled, an interrupt will also be generated on the falling edge of the gate signal (at the end of the accumulation cycle).

Enabling an interrupt is accomplished via the respective Timer Interrupt Enable bit, T1IE. The timer interrupt enable bit is located in the IEC0 Control register in the interrupt controller.

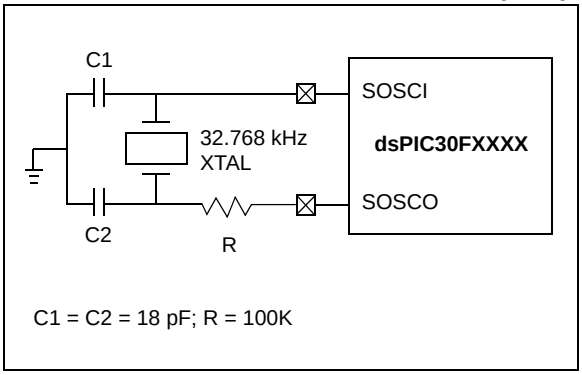
9.5 Real-Time Clock

Timer1, when operating in Real-Time Clock (RTC) mode, provides time-of-day and event time-stamping capabilities. Key operational features of the RTC are:

- Operation from 32 kHz LP oscillator
- 8-bit prescaler
- Low power
- Real-Time Clock interrupts

These operating modes are determined by setting the appropriate bit(s) in the T1CON Control register

FIGURE 9-2: RECOMMENDED COMPONENTS FOR TIMER1 LP OSCILLATOR REAL-TIME CLOCK (RTC)



9.5.1 RTC OSCILLATOR OPERATION

When TON = 1, TCS = 1 and TGATE = 0, the timer increments on the rising edge of the 32 kHz LP oscillator output signal, up to the value specified in the Period register, and is then reset to '0'.

The TSYNC bit must be asserted to a logic '0' (Asynchronous mode) for correct operation.

Enabling LPOSCEN (OSCCON<1>) will disable the normal Timer and Counter modes and enable a timer carry-out wake-up event.

When the CPU enters Sleep mode, the RTC will continue to operate, provided the 32 kHz external crystal oscillator is active and the control bits have not been changed. The TSIDL bit should be cleared to '0' in order for RTC to continue operation in Idle mode.

9.5.2 RTC INTERRUPTS

When an interrupt event occurs, the respective Timer Interrupt Flag, T1IF, is asserted and an interrupt will be generated, if enabled. The T1IF bit must be cleared in software. The respective Timer Interrupt Flag, T1IF, is located in the IFS0 Status register in the interrupt controller.

Enabling an interrupt is accomplished via the respective Timer Interrupt Enable bit, T1IE. The Timer Interrupt Enable bit is located in the IEC0 control register in the interrupt controller.

TABLE 9-1: TIMER1 REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TMR1	0100	Timer1 Register																uuuu uuuu uuuu uuuu
PR1	0102	Period Register 1																1111 1111 1111 1111
T1CON	0104	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note 1: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

TABLE 10-1: TIMER2/3 REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TMR2	0106	Timer2 Register																uuuu uuuu uuuu uuuu
TMR3HLD	0108	Timer3 Holding Register (For 32-bit timer operations only)																uuuu uuuu uuuu uuuu
TMR3	010A	Timer3 Register																uuuu uuuu uuuu uuuu
PR2	010C	Period Register 2																1111 1111 1111 1111
PR3	010E	Period Register 3																1111 1111 1111 1111
T2CON	0110	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T32	—	TCS	—	0000 0000 0000 0000
T3CON	0112	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note 1: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

11.0 TIMER4/5 MODULE

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the *dsPIC30F Family Reference Manual* (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Reference Manual"* (DS70157).

This section describes the second 32-bit general purpose timer module (Timer4/5) and associated operational modes. Figure 11-1 depicts the simplified block diagram of the 32-bit Timer4/5 module. Figure 11-2 and Figure 11-3 illustrate Timer4/5 configured as two independent 16-bit timers, Timer4 and Timer5, respectively.

Note: Timer4 is a 'Type B' timer and Timer5 is a 'Type C' timer. Please refer to the appropriate timer type in **Section 24.0 "Electrical Characteristics"** of this document.

The Timer4/5 module is similar in operation to the Timer 2/3 module. However, there are some differences, which are as follows:

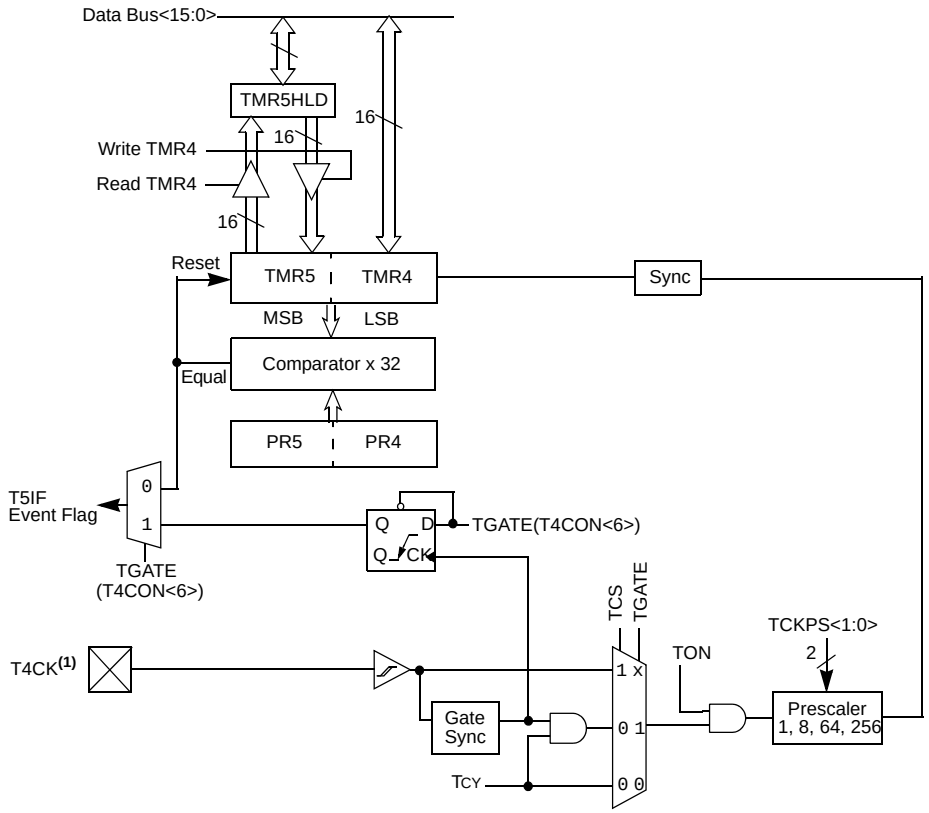
- The Timer4/5 module does not support the ADC event trigger feature
- Timer4/5 can not be utilized by other peripheral modules such as input capture and output compare

The operating modes of the Timer4/5 module are determined by setting the appropriate bit(s) in the 16-bit T4CON and T5CON SFRs.

For 32-bit timer/counter operation, Timer4 is the least significant word and Timer5 is the most significant word of the 32-bit timer.

Note: For 32-bit timer operation, T5CON control bits are ignored. Only T4CON control bits are used for setup and control. Timer4 clock and gate inputs are utilized for the 32-bit timer module, but an interrupt is generated with the Timer5 Interrupt Flag (T5IF) and the interrupt is enabled with the Timer5 Interrupt Enable bit (T5IE).

FIGURE 11-1: 32-BIT TIMER4/5 BLOCK DIAGRAM



Note 1: T4CK is not implemented and this line is tied to VSS.

2: Timer configuration bit, T32 (T2CON<3>), must be set to '1' for a 32-bit timer/counter operation. All control bits are respective to the T4CON register.

13.0 OUTPUT COMPARE MODULE

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the *dsPIC30F Family Reference Manual* (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Reference Manual"* (DS70157).

This section describes the output compare module and associated operational modes. The features provided by this module are useful in applications requiring operational modes, such as:

- Generation of Variable Width Output Pulses
- Power Factor Correction

Figure 13-1 illustrates a block diagram of the output compare module.

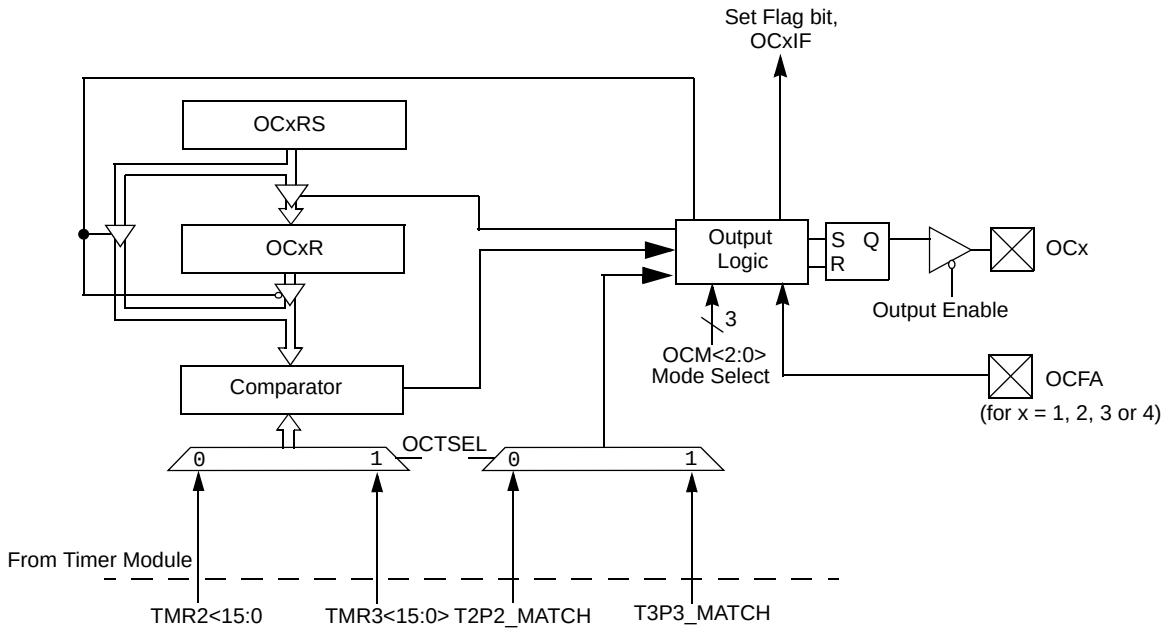
The key operational features of the output compare module include:

- Timer2 and Timer3 Selection mode
- Simple Output Compare Match mode
- Dual Output Compare Match mode
- Simple PWM mode
- Output Compare during Sleep and Idle modes
- Interrupt on Output Compare/PWM Event

These operating modes are determined by setting the appropriate bits in the 16-bit OCxCON SFR (where x = 1, 2, ... N). The dsPIC30F4011/4012 devices have 4/2 compare channels, respectively.

OCxRS and OCxR in the figure represent the Dual Compare registers. In the Dual Compare mode, the OCxR register is used for the first compare and OCxRS is used for the second compare.

FIGURE 13-1: OUTPUT COMPARE MODE BLOCK DIAGRAM



Note: Where 'x' is shown, reference is made to the registers associated with the respective output compare channels 1 through N.

14.3 Position Measurement Mode

There are two Measurement modes which are supported and are termed x2 and x4. These modes are selected by the QEIM<2:0> (QEICON<10:8>) mode select bits.

When control bits, QEIM<2:0> = 100 or 101, the x2 Measurement mode is selected and the QEI logic only looks at the Phase A input for the position counter increment rate. Every rising and falling edge of the Phase A signal causes the position counter to be incremented or decremented. The Phase B signal is still utilized for the determination of the counter direction just as in the x4 mode.

Within the x2 Measurement mode, there are two variations of how the position counter is reset:

1. Position counter reset by detection of index pulse, QEIM<2:0> = 100.
2. Position counter reset by match with MAXCNT, QEIM<2:0> = 101.

When control bits, QEIM<2:0> = 110 or 111, the x4 Measurement mode is selected and the QEI logic looks at both edges of the Phase A and Phase B input signals. Every edge of both signals causes the position counter to increment or decrement.

Within the x4 Measurement mode, there are two variations of how the position counter is reset:

1. Position counter reset by detection of index pulse, QEIM<2:0> = 110.
2. Position counter reset by match with MAXCNT, QEIM<2:0> = 111.

The x4 Measurement mode provides for finer resolution data (more position counts) for determining motor position.

14.4 Programmable Digital Noise Filters

The digital noise filter section is responsible for rejecting noise on the incoming quadrature signals. Schmitt Trigger inputs and a three-clock cycle delay filter combine to reject low-level noise and large, short duration, noise spikes that typically occur in noise prone applications, such as a motor system.

The filter ensures that the filtered output signal is not permitted to change until a stable value has been registered for three consecutive clock cycles.

For the QEA, QEB and INDX pins, the clock divide frequency for the digital filter is programmed by bits QECK<2:0> (DFLTCON<6:4>) and are derived from the base instruction cycle TCY.

To enable the filter output for channels QEA, QEB and INDX, the QEOUT bit must be '1'. The filter network for all channels is disabled on POR and BOR.

14.5 Alternate 16-bit Timer/Counter

When the QEI module is not configured for the QEI mode, QEIM<2:0> = 001, the module can be configured as a simple 16-bit timer/counter. The setup and control of the auxiliary timer is accomplished through the QEICON SFR register. This timer functions identically to Timer1. The QEA pin is used as the timer clock input.

When configured as a timer, the POSCNT register serves as the Timer Count register and the MAXCNT register serves as the Period register. When a Timer/Period register match occurs, the QEI interrupt flag will be asserted.

The only exception between the general purpose timers and this timer is the added feature of external up/down input select. When the UPDN pin is asserted high, the timer will increment up. When the UPDN pin is asserted low, the timer will be decremented.

Note:	Changing the operational mode (i.e., from QEI to timer or vice versa) will not affect the Timer/Position Count register contents.

The UPDN control/status bit (QEICON<11>) can be used to select the count direction state of the Timer register. When UPDN = 1, the timer will count up. When UPDN = 0, the timer will count down.

In addition, control bit, UPDN_SRC (QEICON<0>), determines whether the timer count direction state is based on the logic state written into the UPDN control/status bit (QEICON<11>) or the QEB pin state. When UPDN_SRC = 1, the timer count direction is controlled from the QEB pin. Likewise, when UPDN_SRC = 0, the timer count direction is controlled by the UPDN bit.

Note:	This timer does not support the External Asynchronous Counter mode of operation. If using an external clock source, the clock will automatically be synchronized to the internal instruction cycle.

14.6 QEI Module Operation During CPU Sleep Mode

14.6.1 QEI OPERATION DURING CPU SLEEP MODE

The QEI module will be halted during the CPU Sleep mode.

14.6.2 TIMER OPERATION DURING CPU SLEEP MODE

During CPU Sleep mode, the timer will not operate because the internal clocks are disabled.

15.13 PWM Update Lockout

For a complex PWM application, the user may need to write up to three duty cycle registers and the Time Base Period register, PTPER, at a given time. In some applications, it is important that all buffer registers be written before the new duty cycle and period values are loaded for use by the module.

The PWM update lockout feature is enabled by setting the UDIS control bit in the PWMCON2 SFR. The UDIS bit affects all duty cycle buffer registers and the PWM Time Base Period buffer, PTPER. No duty cycle changes or period value changes will have effect while UDIS = 1.

15.14 PWM Special Event Trigger

The PWM module has a special event trigger that allows A/D conversions to be synchronized to the PWM time base. The A/D sampling and conversion time may be programmed to occur at any point within the PWM period. The special event trigger allows the user to minimize the delay between the time when A/D conversion results are acquired and the time when the duty cycle value is updated.

The PWM special event trigger has an SFR named SEVTCMP and five control bits to control its operation. The PTMR value for which a special event trigger should occur is loaded into the SEVTCMP register. When the PWM time base is in a Continuous Up/Down Count mode, an additional control bit is required to specify the counting phase for the special event trigger. The count phase is selected using the SEVTDIR control bit in the SEVTCMP SFR. If the SEVTDIR bit is cleared, the special event trigger will occur on the upward counting cycle of the PWM time base. If the SEVTDIR bit is set, the special event trigger will occur on the downward count cycle of the PWM time base. The SEVTDIR control bit has no effect unless the PWM time base is configured for a Continuous Up/Down Count mode.

15.14.1 SPECIAL EVENT TRIGGER POSTSCALER

The PWM special event trigger has a postscaler that allows a 1:1 to 1:16 postscale ratio. The postscaler is configured by writing the SEVOPS<3:0> control bits in the PWMCON2 SFR.

The special event output postscaler is cleared on the following events:

- Any write to the SEVTCMP register
- Any device Reset

15.15 PWM Operation During CPU Sleep Mode

The Fault A input pin has the ability to wake the CPU from Sleep mode. The PWM module generates an interrupt if the Fault pin is driven low while in Sleep.

15.16 PWM Operation During CPU Idle Mode

The PTCON SFR contains a PTSIDL control bit. This bit determines if the PWM module will continue to operate or stop when the device enters Idle mode. If PTSIDL = 0, the module will continue to operate. If PTSIDL = 1, the module will stop operation as long as the CPU remains in Idle mode.

18.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART) MODULE

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the *dsPIC30F Family Reference Manual* (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Reference Manual"* (DS70157).

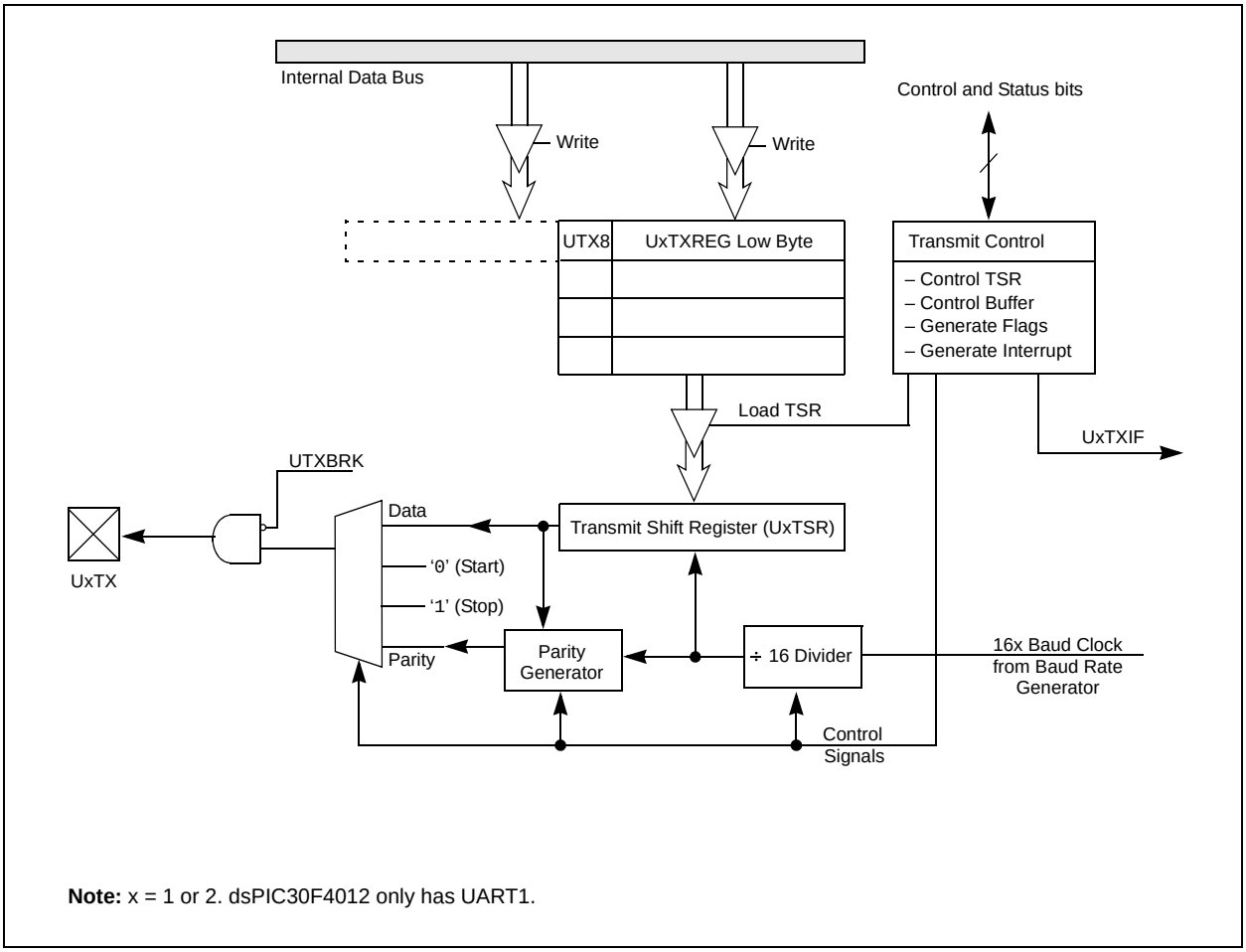
This section describes the Universal Asynchronous Receiver/Transmitter communications module.

18.1 UART Module Overview

The key features of the UART module are:

- Full-Duplex, 8 or 9-bit Data Communication
- Even, Odd or No Parity Options (for 8-bit data)
- One or Two Stop bits
- Fully Integrated Baud Rate Generator with 16-bit Prescaler
- Baud Rates ranging from 38 bps to 1.875 Mbps at a 30 MHz Instruction Rate
- 4-Word Deep Transmit Data Buffer
- 4-Word Deep Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for Interrupt Only on Address Detect (9th bit = 1)
- Separate Transmit and Receive Interrupts
- Loopback mode for Diagnostic Support

FIGURE 18-1: UART TRANSMITTER BLOCK DIAGRAM



Note: x = 1 or 2. dsPIC30F4012 only has UART1.

TABLE 21-7: SYSTEM INTEGRATION REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
RCON	0740	TRAPR	IOPUWR	BGST	—					EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	Depends on type of Reset.
OSCCON	0742	TUN3	TUN2	COSC<1:0>		TUN1	TUN0	NOSC<1:0>		POST<1:0>		LOCK	—	CF	—	LPOSCEN	OSWEN	Depends on Configuration bits.

Legend: — = unimplemented bit, read as '0'
Note 1: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

TABLE 21-8: DEVICE CONFIGURATION REGISTER MAP(1)

Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FOSC	F80000	FCKSM<1:0>		—	—	—	—	FOS<1:0>		—	—	—	—	FPR<3:0>			
FWDT	F80002	FWDTEN	—	—	—	—	—	—	—	—	—	FWPSA<1:0>		FWPSB<3:0>			
FBORPOR	F80004	MCLREN	—	—	—	—	PWMPIN	HPOL	LPOL	BOREN	—	BORV<1:0>		—	—	FPWRT<1:0>	
FBS	F80006	—	—	Reserved(2)		—	—	—	Reserved(2)	—	—	—	—	Reserved(2)			
FSS	F80008	—	—	Reserved(2)		—	—	Reserved(2)		—	—	—	—	Reserved(2)			
FGS	F8000A	—	—	—	—	—	—	—	—	—	—	—	—	—	Reserved(2)	GCP	GWRP
FICD	F8000C	BKBUG	COE	—	—	—	—	—	—	—	—	—	—	—	—	ICS<1:0>	

Legend: — = unimplemented bit, read as '0'
Note 1: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.
2: Reserved bits read as '1' and must be programmed as '1'.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all table reads and writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction, require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles. The double-word instructions execute in two instruction cycles.

Note: For more details on the instruction set, refer to the *"16-bit MCU and DSC Reference Manual"* (DS70157).

TABLE 22-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

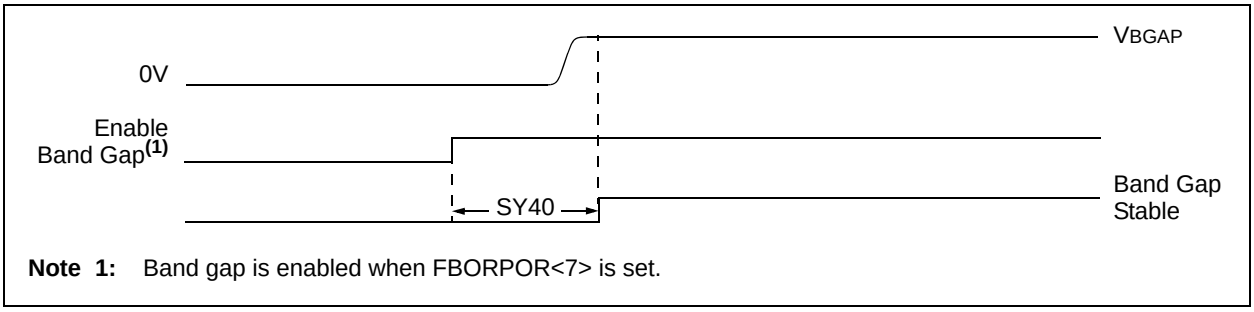
Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
<n:m>	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.w	Word mode selection (default)
Acc	One of two accumulators {A, B}
AWB	Accumulator Write-Back Destination Address register ∈ {W13, [W13]+=2}
bit4	4-bit bit selection field (used in word addressed instructions) ∈ {0...15}
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address ∈ {0x0000...0x1FFF}
lit1	1-bit unsigned literal ∈ {0,1}
lit4	4-bit unsigned literal ∈ {0...15}
lit5	5-bit unsigned literal ∈ {0...31}
lit8	8-bit unsigned literal ∈ {0...255}
lit10	10-bit unsigned literal ∈ {0...255} for Byte mode, {0:1023} for Word mode
lit14	14-bit unsigned literal ∈ {0...16384}
lit16	16-bit unsigned literal ∈ {0...65535}
lit23	23-bit unsigned literal ∈ {0...8388608}; LSB must be 0
None	Field does not require an entry, may be blank
OA, OB, SA, SB	DSP Status bits: ACCA Overflow, ACCB Overflow, ACCA Saturate, ACCB Saturate
PC	Program Counter
Slit10	10-bit signed literal ∈ {-512...511}
Slit16	16-bit signed literal ∈ {-32768...32767}
Slit6	6-bit signed literal ∈ {-16...16}

TABLE 24-20: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SY10	TmcL	$\overline{MCLR}$ Pulse Width (low)	2	—	—	µs	-40°C to +85°C
SY11	TPWRT	Power-up Timer Period	2 8 32	4 16 64	6 24 96	ms	-40°C to +85°C, VDD = 5V User programmable
SY12	TPOR	Power-on Reset Delay	3	10	30	µs	-40°C to +85°C
SY13	TIOZ	I/O High-Impedance from $\overline{MCLR}$ Low or Watchdog Timer Reset	—	0.8	1.0	µs	
SY20	TWDT1 TWDT2 TWDT3	Watchdog Timer Time-out Period (No Prescaler)	0.6 0.8 1.0	2.0 2.0 2.0	3.4 3.2 3.0	ms ms ms	VDD = 2.5V VDD = 3.3V, ±10% VDD = 5V, ±10%
SY25	TBOR	Brown-out Reset Pulse Width(3)	100	—	—	µs	VDD ≤VBOR (D034)
SY30	TOST	Oscillation Start-up Timer Period	—	1024 TOSC	—	—	TOSC = OSC1 period
SY35	TFSCM	Fail-Safe Clock Monitor Delay	—	500	900	µs	-40°C to +85°C

Note 1: These parameters are characterized but not tested in manufacturing.
2: Data in "Typ" column is at 5V, 25°C unless otherwise stated.
3: Refer to Figure 24-1 and Table 24-10 for BOR.

FIGURE 24-6: BAND GAP START-UP TIME CHARACTERISTICS



Note 1: Band gap is enabled when FBORPOR<7> is set.

TABLE 24-21: BAND GAP START-UP TIME REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SY40	TBGAP	Band Gap Start-up Time	—	40	65	µs	Defined as the time between the instant that the band gap is enabled and the moment that the band gap reference voltage is stable (RCON<13> status bit)

Note 1: These parameters are characterized but not tested in manufacturing.
2: Data in "Typ" column is at 5V, 25°C unless otherwise stated.

FIGURE 24-12: MOTOR CONTROL PWM MODULE FAULT TIMING CHARACTERISTICS

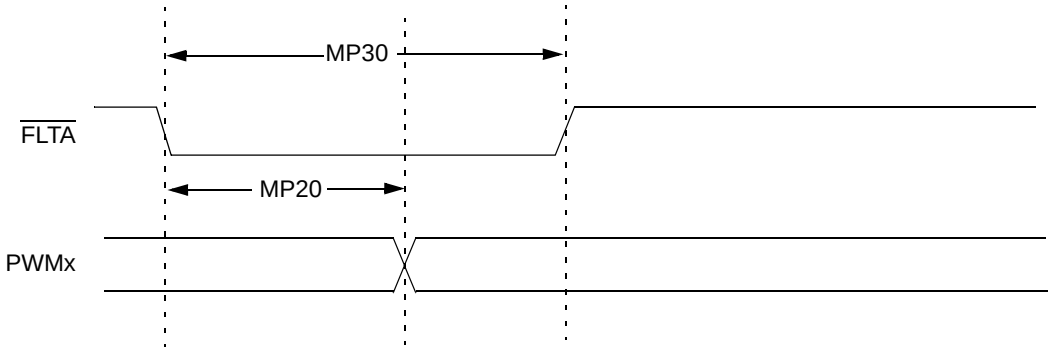
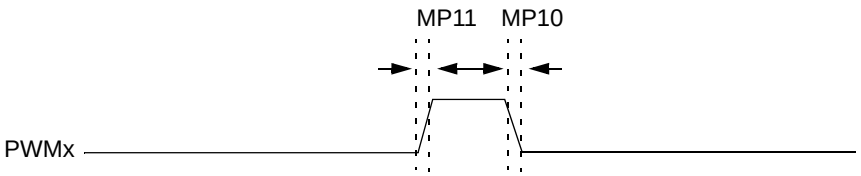


FIGURE 24-13: MOTOR CONTROL PWM MODULE TIMING CHARACTERISTICS



Note: Refer to Figure 24-2 for load conditions.

TABLE 24-29: MOTOR CONTROL PWM MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
MP10	TFPWM	PWM Output Fall Time	—	—	—	ns	See parameter DO32
MP11	TRPWM	PWM Output Rise Time	—	—	—	ns	See parameter DO31
MP20	TFD	Fault Input ↓to PWM I/O Change	—	—	50	ns	
MP30	TFH	Minimum Pulse Width	50	—	—	ns	

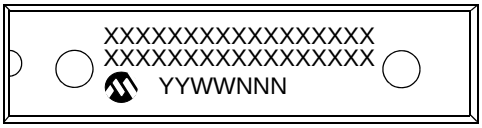
Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ" column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

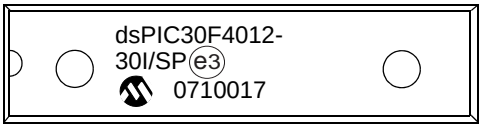
25.0 PACKAGING INFORMATION

25.1 Package Marking Information

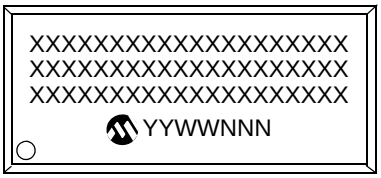
28-Lead PDIP (Skinny DIP)



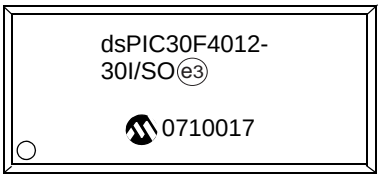
Example



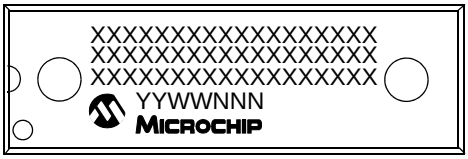
28-Lead SOIC



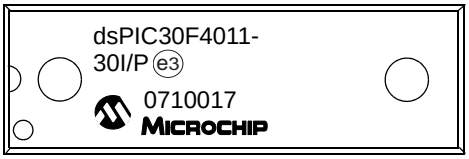
Example



40-Lead PDIP



Example



Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

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